PLAP1 Polisher Operating Procedure (Logitech)

- 1. Turn System ON.
- 2. Place Glass Polishing Wheel on rotation table.
- 3. Use JoyStick to navigate the display screen. (UP/DOWN/ROTATE)
- 4. Press center of JoyStick to make your selection.
- 5. Select PLATE and set at 35rpm.
- 6. Select ABRASIVE and set to ON.
- 7. Do NOT select ARM.
- 8. Select SET TIME, Enable Timer, Reset Timer, and enter desired Time.
- 9. Place 9um or 1um AlOxide drum on rollers on top of system.

NOTE: 9um AlOxide grit at 35 rpm laps Silicon at a rate of ~ 10um/min. 1um AlOxide grit at 35rpm laps Silicon at a rate of ~ 1um/min.

- 10. Open Valve on drum and set dispense rate to ~ 1 drop every 5 seconds.
- 11. Turn Vac Pump ON.
- 12. Verify that the Air Inlet knob is closed.
- 13. Place your frosted glass polishing pad with wax mounted sample onto the Vacuum Polishing Chuck fixture.
- 14. Verify that Vacuum is present and sample is held in place.
- 15. Select START to begin rotation of the polishing wheel and dispensing of the AlOxide grit. Be sure the plate is completely wet with AlOxide grit.
- 16. Select STOP.
- 17. Place Vacuum Polishing Chuck fixture with sample attached on polishing wheel using the Chuck Holder arm as a guide.
- 18. Verify that the Chuck is sitting flat on the Polishing Wheel.
- 19. Read the micrometer gage to determine starting point for removal.
- 20. Select START.
- 21. Chuck should rotate counterclockwise when Polishing Wheel is rotating.
- 22. Upon completion select STOP.
- 23. Remove Chuck.
- 24. Turn Vac Pump OFF, and OPEN Air Inlet knob to remove all vacuum from Chuck.
- 25. Remove sample from Chuck.
- 26. Close Valve on AlOxide drum and remove it from rollers.
- 27. Rinse Polishing Wheel with water and dry softly with clean room wipe.
- 28. Turn system OFF.